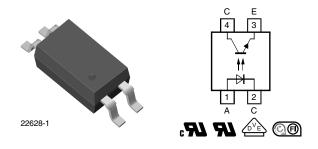


Optocoupler, Phototransistor Output, Single Channel, Half Pitch Mini-Flat Package



DESCRIPTION

The TCMT111X series consist of a phototransistor optically coupled to a gallium arsenide infrared-emitting diode in a 4 pin package.

APPLICATIONS

- Programmable logic controllers
- Modems
- · Answering machines
- · General applications

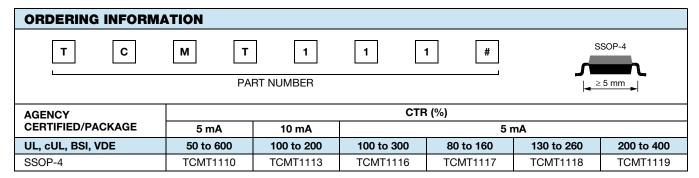
FEATURES

- Low profile package (half pitch)
- AC isolation test voltage 3750 V_{RMS}
- · Low coupling capacitance of typical 0.3 pF
- · Current transfer ratio (CTR) selected into groups
- · Low temperature coefficient of CTR
- Wide ambient temperature range
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

COMPLIANT



- UL1577, file no. E76222, double protection
- cUL component acceptance service no. 5A, double protection
- DIN EN 60747-5-5 (VDE 0884-5)
- FIMKO: FI EN 60950-1:2006
- BSI: BS EN60065:2002 BS EN60950-1:2006
- CQC GB 8898-2011, GB 4943.1-2011 (suitable for installation altitude below 2000 m)



ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT		
INPUT						
Reverse voltage		V _R	6	V		
Forward current		I _F	50	mA		
Forward surge current	t _P ≤ 10 μs	I _{FSM}	1.5	Α		
Power dissipation		P _{diss}	80	mW		
Junction temperature		Tj	125	°C		



TCMT111. Series

www.vishay.com

Vishay Semiconductors

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
OUTPUT							
Collector emitter voltage		V _{CEO}	70	V			
Emitter collector voltage		V _{ECO}	7	V			
Collector current		I _C	50	mA			
Collector peak current	$t_p/T = 0.5, t_p \le 10 \text{ ms}$	I _{CM}	100	mA			
Power dissipation		P _{diss}	150	mW			
Junction temperature		Tj	125	°C			
COUPLER							
Total power dissipation		P _{tot}	230	mW			
Operating ambient temperature range		T _{amb}	-40 to +110	°C			
Storage temperature range		T _{stg}	-40 to +125	°C			
Soldering temperature (1)		T _{sld}	260	°C			

Notes

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- (1) Wave soldering three cycles are allowed. Also refer to "Assembly Instructions" (www.vishay.com/doc?80054).

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT						
Forward voltage	I _F = 5 mA	V _F	-	1.08	1.4	V
Junction capacitance	$V_R = 0$, $f = 1$ MHz	C _j	-	8	-	pF
OUTPUT						
Collector emitter voltage	I _C = 100 μA	V _{CEO}	70	-	-	V
Emitter collector voltage	I _E = 100 μA	V _{ECO}	7	-	-	V
Collector dark current	$V_{CE} = 20 \text{ V}, I_F = 0$	I _{CEO}	-	-	100	nA
COUPLER						
Collector emitter saturation voltage	$I_F = 10 \text{ mA}, I_C = 1 \text{ mA}$	V _{CEsat}	-	0.1	0.3	V
Cut-off frequency	V_{CE} = 5 V, I_F = 10 mA, R_L = 100 Ω	f _c	-	100	-	kHz
Coupling capacitance	f = 1 MHz	C _k	-	0.3	-	pF

Note

• Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
I _C /I _F	$V_{CE} = 5 \text{ V}, I_{F} = 5 \text{ mA}$	TCMT1110	CTR	50	-	600	%
	V _{CE} = 5 V, I _F = 10 mA	TCMT1113	CTR	100	-	200	%
		TCMT1114	CTR	160	-	320	%
	$V_{CE} = 5 \text{ V}, I_F = 5 \text{ mA}$	TCMT1117	CTR	80	-	160	%
		TCMT1118	CTR	130	-	260	%
		TCMT1119	CTR	200	-	400	%



TCMT111. Series

Vishay Semiconductors

SWITCHING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Delay time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω , (see figure 1)	t _d	-	4	-	μs
Rise time	$V_S = 5 \text{ V}, I_C = 2 \text{ mA}, R_L = 100 \Omega,$ (see figure 1)	t _r	-	5.5	-	μs
Fall time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω , (see figure 1)	t _f	-	7	-	μs
Storage time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω , (see figure 1)	ts	-	1.5	-	μs
Turn-on time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω , (see figure 1)	t _{on}	-	9.5	-	μs
Turn-off time	V_S = 5 V, I_C = 2 mA, R_L = 100 Ω , (see figure 1)	t _{off}	-	8	-	μs
Turn-on time	$V_S = 5 \text{ V, I}_F = 10 \text{ mA, R}_L = 1 \text{ k}\Omega,$ (see figure 2)	t _{on}	-	3	-	μs
Turn-off time	$V_S = 5 \text{ V}, I_F = 10 \text{ mA}, R_L = 1 \text{ k}\Omega,$ (see figure 2)	t _{off}	-	20	-	μs

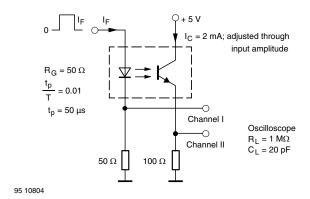


Fig. 1 - Test Circuit, Non-Saturated Operation

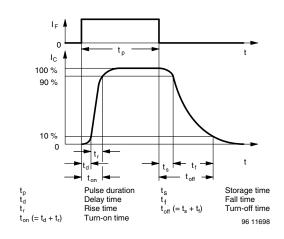


Fig. 3 - Switching Times

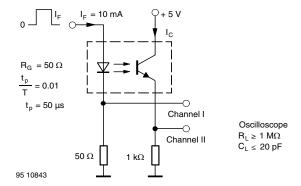


Fig. 2 - Test Circuit, Saturated Operation



TCMT111. Series

www.vishay.com

Vishay Semiconductors

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification (according to IEC 68 part 1)			55/110/21	
Comparative tracking index		CTI	175	
Maximum rated withstanding isolation voltage	40 % to 60 % RH, AC test of 1 min	V _{ISO}	3750	V_{RMS}
Maximum transient isolation voltage		V _{IOTM}	6000	V
Maximum repetitive peak isolation voltage		V _{IORM}	707	V
Insulation resistance	V _{IO} = 500 V, T _{amb} = 100 °C	R _{IO}	10 ¹¹	Ω
Isolation resistance (under fault conditions)	$V_{IO} = 500 \text{ V}, T_{amb} = T_{SI}$	R _{IO}	10 ⁹	Ω
Output safety power		P_{SO}	350	mW
Input safety current		I _{SI}	200	mA
Input safety temperature		T_{SI}	175	°C
Apparent charge test voltage (method A)	V_{IORM} x 1.6 = V_{PR} , type and sample test t_m = 60 s, partial discharge < 5 pC	V_{PR}	1132	V _{peak}
Apparent charge test voltage (method B)	V_{IORM} x 1.875 = V_{PR} , 100 % production test with t_m = 1 s, partial discharge < 5 pC	V _{PR}	1326	V _{peak}
Creepage distance			≥ 5	mm
Clearance distance			≥ 5	mm
Insulation thickness		DTI	≥ 0.4	mm
Environment (pollution degree in accordance to DII	N VDE 0109)		2	

Note

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

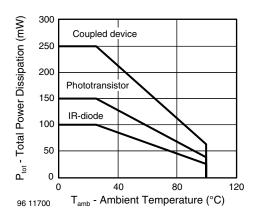


Fig. 4 - Total Power Dissipation vs. Ambient Temperature

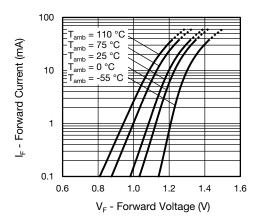


Fig. 5 - Forward Voltage vs. Forward Current

[•] As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with the safety ratings shall be ensured by means of protective circuits.



Vishay Semiconductors

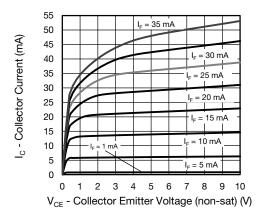


Fig. 6 - Collector Current vs. Collector Emitter Voltage

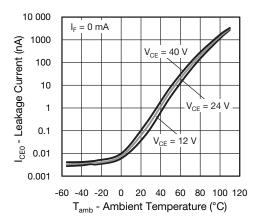


Fig. 7 - Leakage Current vs. Ambient Temperature

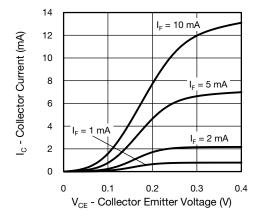


Fig. 8 - Collector Current vs. Collector Emitter Voltage

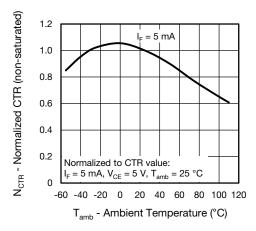


Fig. 9 - Normalized Current Transfer Ratio (non-saturated) vs.

Ambient Temperature

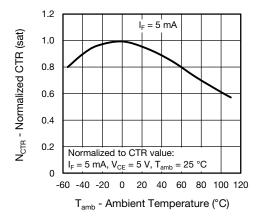


Fig. 10 - Normalized Current Transfer Ratio (saturated) vs.
Ambient Temperature

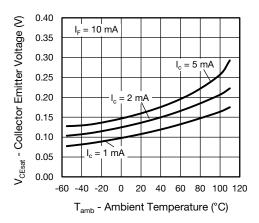


Fig. 11 - Collector Emitter Voltage vs. Ambient Temperature



Vishay Semiconductors

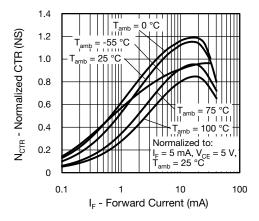


Fig. 12 - Normalized CTR (non-saturated) vs. Forward Current

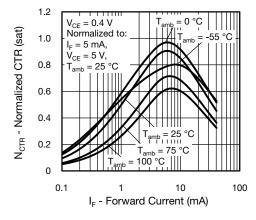


Fig. 13 - Normalized CTR (saturated) vs. Forward Current

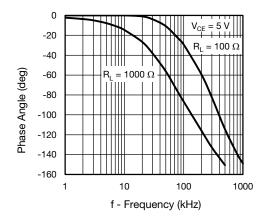


Fig. 14 - F_{CTR} vs. Phase Angle

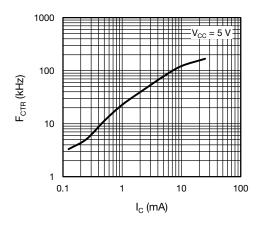


Fig. 15 - F_{CTR} vs. Collector Current

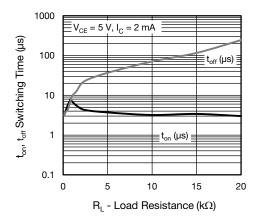


Fig. 16 - Switching Time vs. Load Resistance

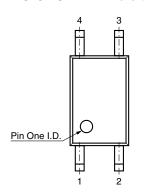
ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishay.com/doc?91000

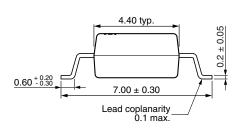


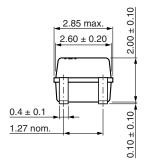
TCMT111. Series

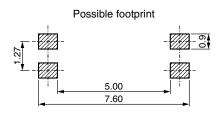
Vishay Semiconductors

PACKAGE DIMENSIONS in millimeters

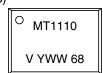








PACKAGE MARKING (example of TCMT1110)



Vishay Semiconductors

PACKAGING INFORMATION (TAPE AND REEL) in millimeters

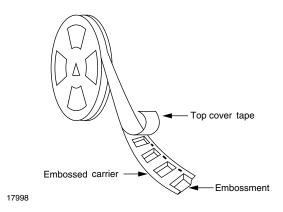


Fig. 17 - Tape and Reel Shipping Medium

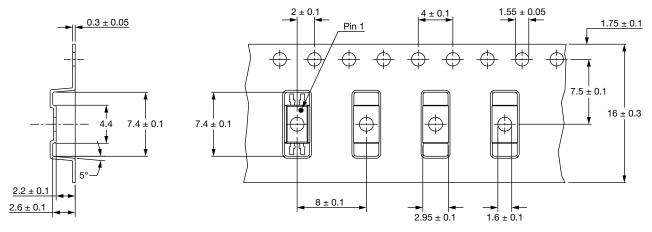


Fig. 18 - Tape and Reel Packing (3000 parts per reel)

SOLDER PROFILES

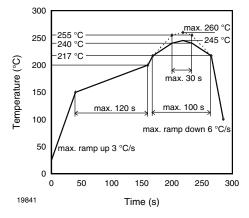


Fig. 19 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD Devices

HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions: T_{amb} < 30 °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000